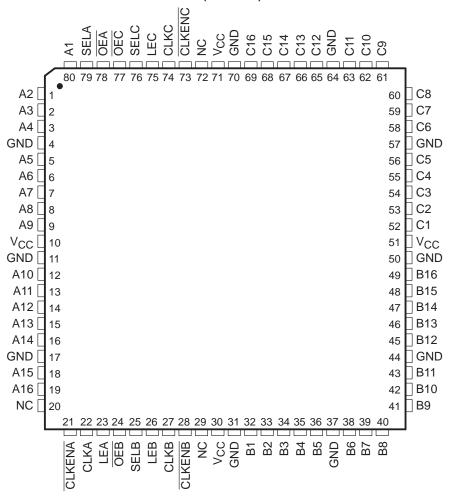
SCBS179E - JUNE 1992 - REVISED MAY 1997

- **Members of the Texas Instruments** Widebus+™ Family
- State-of-the-Art *EPIC-IIB™* BiCMOS Design Significantly Reduces Power Dissipation
- **UBE** ™ (Universal Bus Exchanger) **Combines D-Type Latches and D-Type** Flip-Flops for Operation in Transparent, Latched, Clocked, or Clock-Enabled Mode
- **ESD Protection Exceeds 2000 V Per** MIL-STD-883, Method 3015
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) $< 0.8 \text{ V at V}_{CC} = 5 \text{ V}, T_A = 25^{\circ}\text{C}$

- **High-Impedance State During Power Up** and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- High-Drive Outputs (-32-mA I_{OH}, 64-mA I_{OL})
- Bus Hold on Data Inputs Eliminates the **Need for External Pullup/Pulldown** Resistors
- Package Options Include 80-Pin Plastic Thin Quad Flat (PN) Package With 12 × 12-mm Body Using 0.5-mm Lead Pitch and 84-Pin Ceramic Quad Flat (HT) Package

'ABTH32316 . . . PN PACKAGE (TOP VIEW)

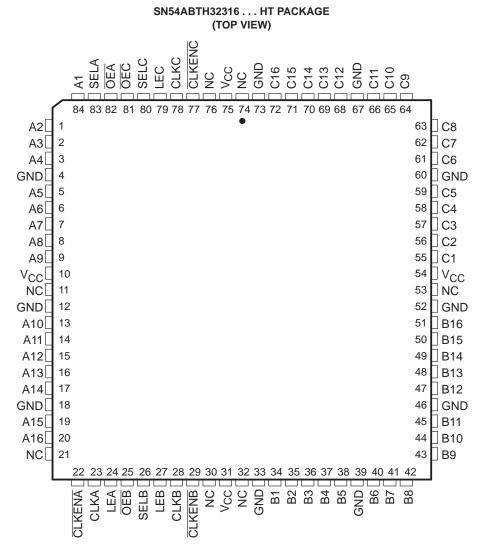




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NC - No internal connection

description

The 'ABTH32316 consist of three 16-bit registered input/output (I/O) ports. These registers combine D-type latches and flip-flops to allow data flow in transparent, latch, and clock modes. Data from one input port can be exchanged to one or more of the other ports. Because of the universal storage element, multiple combinations of real-time and stored data can be exchanged among the three ports.

Data flow in each direction is controlled by the output-enable (\overline{OEA} , \overline{OEB} , and \overline{OEC}), select-control (SELA, SELB, and SELC), latch-enable (LEA, LEB, and LEC), and clock (CLKA, CLKB, and CLKC) inputs. The A data register operates in the transparent mode when LEA is high. When LEA is low, data is latched if CLKA is held at a high or low logic level. If LEA and clock-enable A (\overline{CLKENA}) are low, data is stored on the low-to-high transition of CLKA. Output data selection is accomplished by the select-control pins. All three ports have active-low output enables, so when the output-enable input is low, the outputs are active; when the output-enable input is high, the outputs are in the high-impedance state.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.



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description (continued)

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN54ABTH32316 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABTH32316 is characterized for operation from –40°C to 85°C.

Function Tables

STORAGE[†]

	INPUTS								
CLKENA	CLKA	LEA	Α	OUTPUT					
Н	Х	L	Χ	Q ₀ ‡					
L	\uparrow	L	L	L					
L	\uparrow	L	Н	н					
Х	Н	L	Χ	Q ₀ ‡					
Х	L	L	Χ	Q ₀ ‡ Q ₀ ‡					
Х	X	Н	L	L					
Х	X	Н	Н	Н					

[†]A-port register shown. B and C ports are similar but use CLKENB, CLKENC, CLKB, CLKC, LEB, and LEC.

A-PORT OUTPUT

INP	UTS	OUTPUT A
OEA	SELA	OUTPUT A
Н	Х	Z
L	Н	Output of C register
L	L	Output of B register

B-PORT OUTPUT

INP	UTS	OUTPUT D
OEB	SELB	OUTPUT B
Н	Χ	Z
L	Н	Output of A register
L	L	Output of C register

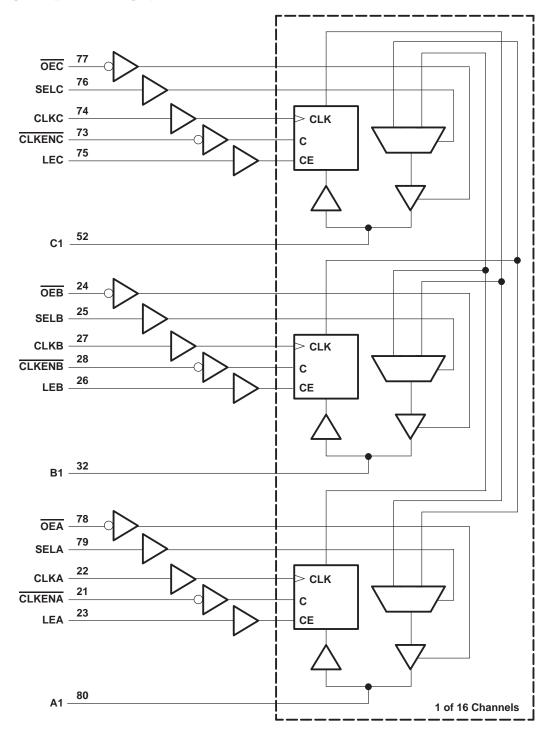
C-PORT OUTPUT

INP	UTS	OUTPUT O
OEC	SELC	OUTPUT C
Н	Х	Z
L	Н	Output of B register
L	L	Output of A register



[‡]Output level before the indicated steady-state input conditions were established

logic diagram (positive logic)



Pin numbers shown are for the PN package.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input voltage range, V _I (except I/O ports) (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, VO	–0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABTH32316	96 mA
SN74ABTH32316	128 mA
Input clamp current, I _{IK} (V _I < 0)	–18 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Package thermal impedance, θ _{JA} (see Note 2): PN package	62°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

			SN54ABTI	H32316	SN74ABTI	H32316	UNIT
			MIN	MAX	MIN	MAX	UNIT
Vcc	Supply voltage	4.5	5.5	4.5	5.5	V	
VIH	High-level input voltage				2		V
V _{IL}	Low-level input voltage		0.8		0.8	V	
VI	Input voltage	0	Vcc	0	Vcc	V	
IOH	High-level output current			-24		-32	mA
loL	Low-level output current			48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
Δt/ΔV _{CC}	Power-up ramp rate	200		200		μs/V	
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused control pins must be held high or low to prevent them from floating.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TECT COME	TEST CONDITIONS			2316	SN74	ABTH32	2316	UNIT	
		1EST COND	IIIONS	MIN	TYP [†]	MAX	MIN	TYP [†]	MAX	UNII	
VIK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2			-1.2	V	
		V _{CC} = 4.5 V,	$I_{OH} = -3 \text{ mA}$	2.5			2.5				
\/~		V _{CC} = 5 V,	$I_{OH} = -3 \text{ mA}$	3			3			v	
VOH		V _{CC} = 4.5 V	$I_{OH} = -24 \text{ mA}$	2						V	
		VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$				2				
VOL		V _{CC} = 4.5 V	I _{OL} = 48 mA			0.55				V	
VOL		VCC = 4.5 V	$I_{OL} = 64 \text{ mA}$						0.55	V	
V _{hys}					100			100		mV	
1.	Control inputs	$V_{CC} = 0 \text{ to } 5.5 \text{ V},$	$V_I = V_{CC}$ or GND			±1			±1		
1	A, B, or C ports	$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V},$	$V_I = V_{CC}$ or GND			±100			±20	μΑ	
lan an	A. D. ou C. norto	V 45V	V _I = 0.8 V	100			100				
l(hold)	A, B, or C ports	V _{CC} = 4.5 V	V _I = 2 V	-100			-100			μΑ	
lozpu [‡]	‡	$V_{CC} = 0$ to 2.1 V, $V_{O} = 0.5$	5 V to 2.7 V, OE = X			±50			±50	μΑ	
lozpd ²	‡	$V_{CC} = 2.1 \text{ V to } 0, V_{O} = 0.5$	5 V to 2.7 V, OE = X			±50			±50	μΑ	
l _{off}		$V_{CC} = 0$,	V_I or $V_O \le 4.5 \text{ V}$			±100			±100	μΑ	
ICEX		$V_{CC} = 5.5 \text{ V}, V_{O} = 5.5 \text{ V}$	Outputs high			50			50	μΑ	
IO§		V _{CC} = 5.5 V,	V _O = 2.5 V	-50	-100	-180	-50	-100	-180	mA	
		V _{CC} = 5.5 V,	Outputs high	its high		2			2		
ICC		$I_{O} = 0$,	Outputs low			40			40	mA	
		$V_I = V_{CC}$ or GND	Outputs disabled			1			1		
Δlcc¶	$V_{CC} = 5.5 \text{ V}$, One input at 3.4 V, Other inputs at V_{CC} or GND					1			0.5	mA	
Ci	Control inputs	V _I = 2.5 V or 0.5 V			3			3		pF	
C _{io}	A, B, or C ports	V _O = 2.5 V or 0.5 V			11.5			11.5		pF	

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

			SN54ABTI	132316	SN74ABTI	H32316	UNIT	
			MIN	MAX	MIN	MAX	UNIT	
fclock	Clock frequency		0	150	0	150	MHz	
	Pulse duration	LE high	3.3		3.3			
t _W	CLK high or low		3.3		3.3		ns	
		A, B, or C before CLK↑	2.6		2.4		ns	
t _{su}	Setup time	A or B before LE↓	2.5		2.1			
		CLKEN before CLK↑	3.5		3.2			
		A, B, or C after CLK↑	1.8		1.4			
th	Hold time	A or B after LE↓	2.4		2.1		ns	
		CLKEN after CLK↑	1.5		1.1			



[‡]This parameter is specified by characterization.

[§] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

 $[\]P$ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

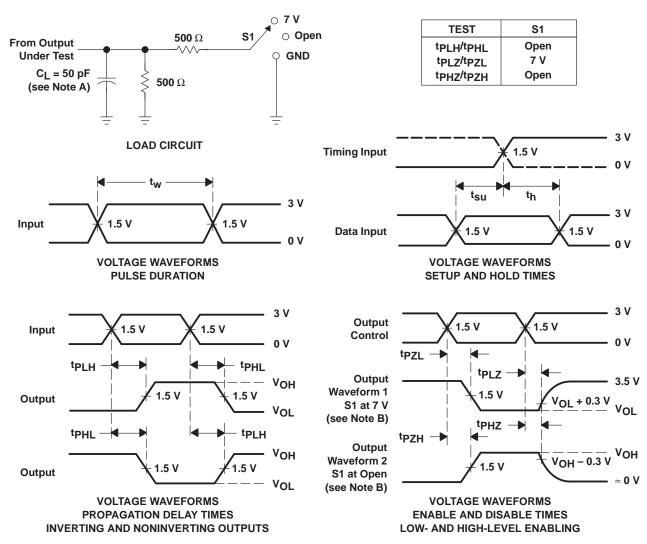
SN54ABTH32316, SN74ABTH32316 16-BIT TRI-PORT UNIVERSAL BUS EXCHANGERS

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM TO		TO SN54ABTH32316		SN74ABTI	UNIT	
FARAMETER	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	UNIT
f _{max}			150		150		MHz
^t PLH	A, B, or C	C, B, or A	0.8	6.5	1.4	6.1	ns
^t PHL	A, b, or C	C, B, 01 A	0.5	6.8	1.1	6.6	115
^t PLH	SEL	A, B, or C	0.8	6.7	1.4	6.5	ns
^t PHL	JEL	A, B, 01 C	0.8	6.8	1.8	6.5	115
^t PLH	LE	A, B, or C	1.5	8	2.6	7.5	ns
^t PHL			1.5	7.4	2.6	6.9	115
^t PLH	CLK	A, B, or C	1.5	8	2.5	7.5	ns
^t PHL	CLK	A, B, OI C	1.5	7.2	2.5	6.7	115
^t PZH	OE	A, B, or C	0.8	6.7	1.5	6.4	no
t _{PZL}		A, B, 01 C	1.5	7.1	2.4	6.8	ns
^t PHZ	 OE	A P or C	0.8	7.2	1.5	6	ns
^t PLZ		A, B, or C	0.8	6.4	1.9	6.1	115

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_{Q} = 50 Ω , t_{f} \leq 2.5 ns, t_{f} \leq 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

5-Sep-2011

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
5962-9680801QXA	ACTIVE	CFP	HT	84	1	TBD	Call TI	Call TI	
SN74ABTH32316PN	ACTIVE	LQFP	PN	80	119	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	
SN74ABTH32316PNG4	ACTIVE	LQFP	PN	80	119	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR	
SNJ54ABTH32316HT	ACTIVE	CFP	HT	84	1	TBD	POST-PLATE	N / A for Pkg Type	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN54ABTH32316, SN74ABTH32316:

Catalog: SN74ABTH32316



5-Sep-2011

• Military: SN54ABTH32316

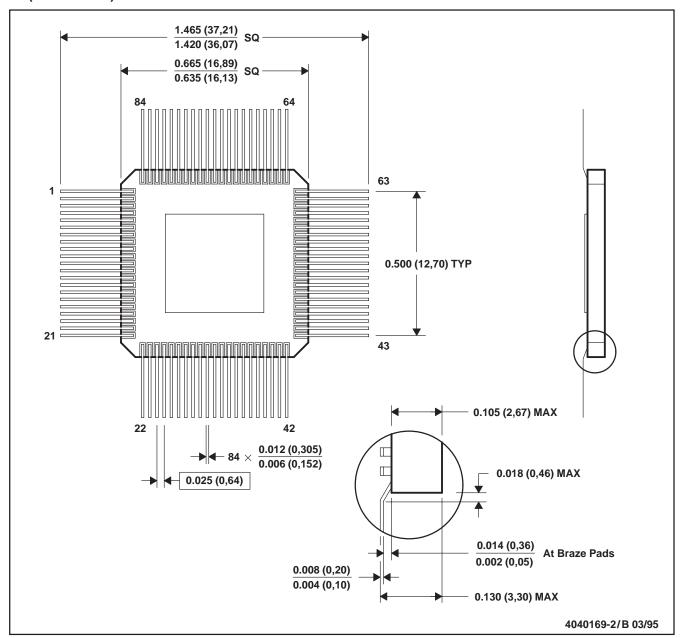
NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

1

HT (S-CQFP-F84)

CERAMIC QUAD FLATPACK



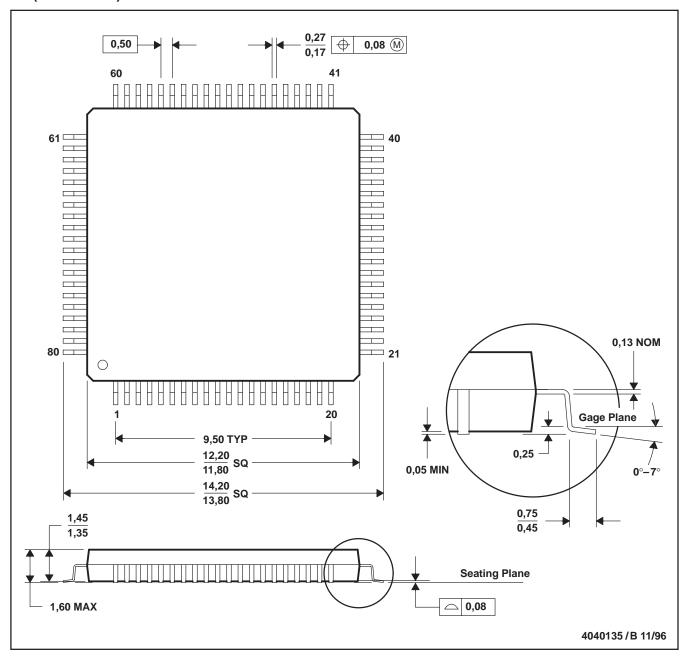
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MO-090 AA



PN (S-PQFP-G80)

PLASTIC QUAD FLATPACK



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Falls within JEDEC MS-026

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